Vishay Siliconix

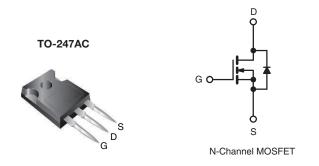
RoHS

COMPLIANT

HALOGEN FREE

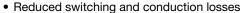
E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V 0.125			
Q _g max. (nC)	130			
Q _{gs} (nC)	15			
Q _{gd} (nC)	39			
Configuration	Single			



FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)



- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
 - LED lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- · Battery chargers
- Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION			
Package	TO-247AC		
Lead (Pb)-free	SiHG30N60E-E3		
Lead (Pb)-free and Halogen-free	SiHG30N60E-GE3		

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	600	V
Gate-Source Voltage			V_{GS}	± 30	7 v
Continuous Proin Current (T = 150 °C)	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	I _D	29	А
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C		18	
Pulsed Drain Current ^a			I _{DM}	65	
Linear Derating Factor				2	W/°C
Single Pulse Avalanche Energy b			E _{AS}	690	mJ
Maximum Power Dissipation			P_{D}	250	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope $V_{DS} = 0 \text{ V to } 80 \text{ % } V_{DS}$		dV/dt	70	1//22	
Reverse Diode dV/dt ^d			18	- V/ns	
Soldering Recommendations (Peak Temperature) c for 10 s				300	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 28.2 mH, $R_g = 25$ Ω , $I_{AS} = 7$ A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$.



Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.5	C/VV	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static				•	•	l .	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 250 μA	-	0.64	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	- V _{GS} , I _D = 250 μA	2.0	2.8	4.0	V
Octo Course Legland	I _{GSS}	V _{GS} = ± 20 V		-	-	± 100	nA
Gate-Source Leakage		,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zava Cata Valtaga Dvain Cuwant		V _{DS} =	V _{DS} = 600 V, V _{GS} = 0 V		-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 600 V	', V _{GS} = 0 V, T _J = 150 °C	-	-	100	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 15 A	-	0.104	0.125	Ω
Forward Transconductance a	9 _{fs}	V _{DS}	_S = 8 V, I _D = 3 A	-	5.4	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,	-	2600	-	
Output Capacitance	C_{oss}		V _{DS} = 100 V,	-	138	-	
Reverse Transfer Capacitance	C_{rss}		f = 1.0 MHz	-	3	-	_
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	98	-	pF
Effective Output Capacitance, Time Related ^b	$C_{o(tr)}$			-	346	-	
Total Gate Charge	Qg			-	85	130	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V I _D = 15 A, V _{DS} = 480 V		-	15	-	nC
Gate-Drain Charge	Q_{gd}			-	39	-	
Turn-On Delay Time	t _{d(on)}		•	-	19	40	
Rise Time	t _r	V_{DD} = 380 V, I_{D} = 15 A, V_{GS} = 10 V, R_{g} = 4.7 Ω		-	32	65	ns
Turn-Off Delay Time	t _{d(off)}			-	63	95	115
Fall Time	t _f			-	36	75	
Gate Input Resistance	R_g	f = 1 MHz, open drain		-	0.63	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	29	
Pulsed Diode Forward Current	I _{SM}			-	-	65	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 15 A, V _{GS} = 0 V		-	-	1.3	V
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 15 \text{A},$ $dI/dt = 100 \text{A/}\mu\text{s}, V_R = 20 \text{V}$		-	402	605	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	7	15	μC
Reverse Recovery Current	I _{RRM}			-	32	65	Α

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

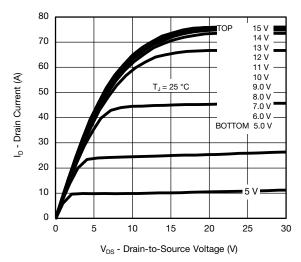


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

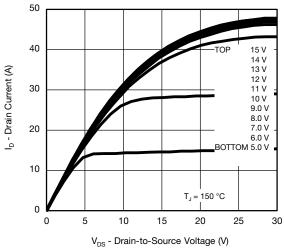


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

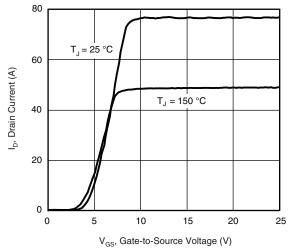


Fig. 3 - Typical Transfer Characteristics

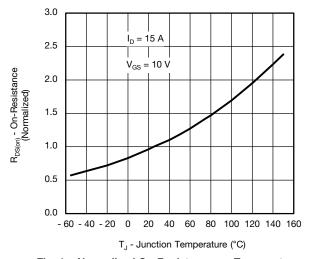


Fig. 4 - Normalized On-Resistance vs. Temperature

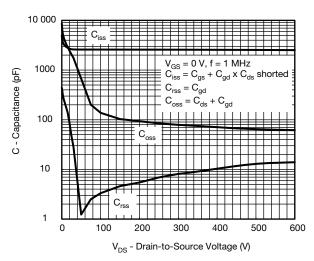


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

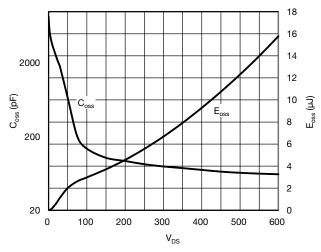


Fig. 6 - Coss and Eoss vs. VDS



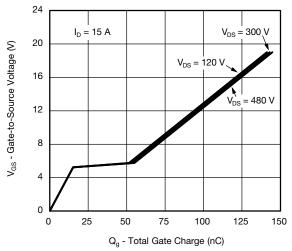


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

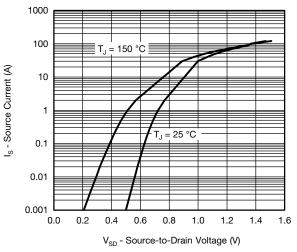


Fig. 8 - Typical Source-Drain Diode Forward Voltage

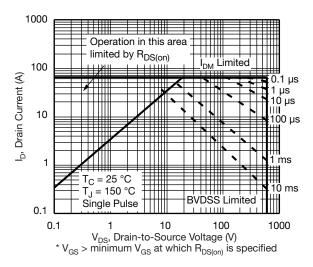


Fig. 9 - Maximum Safe Operating Area

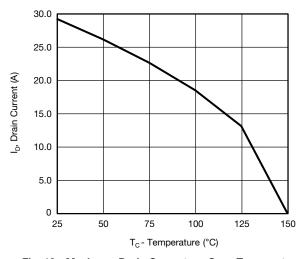


Fig. 10 - Maximum Drain Current vs. Case Temperature

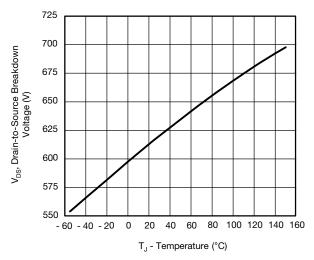
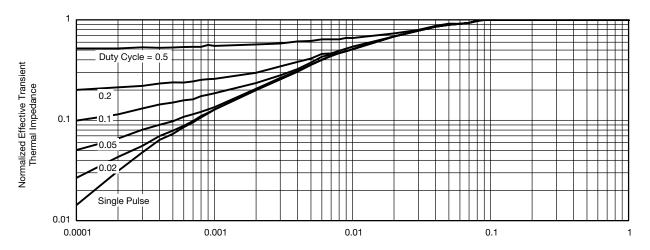
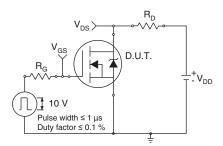


Fig. 11 - Temperature vs. Drain-to-Source Voltage





Square Wave Pulse Duration (s)
Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case



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Fig. 13 - Switching Time Test Circuit

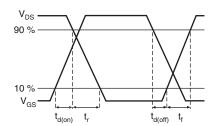


Fig. 14 - Switching Time Waveforms

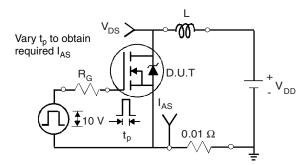


Fig. 15 - Unclamped Inductive Test Circuit

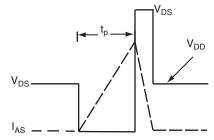


Fig. 16 - Unclamped Inductive Waveforms

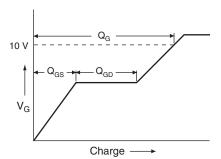


Fig. 17 - Basic Gate Charge Waveform

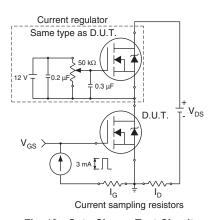
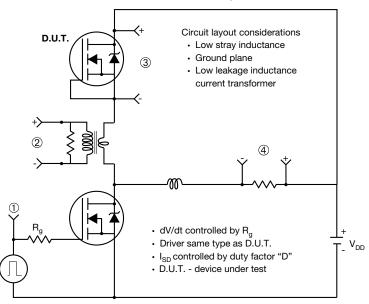


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



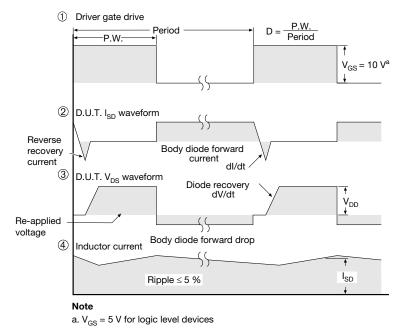
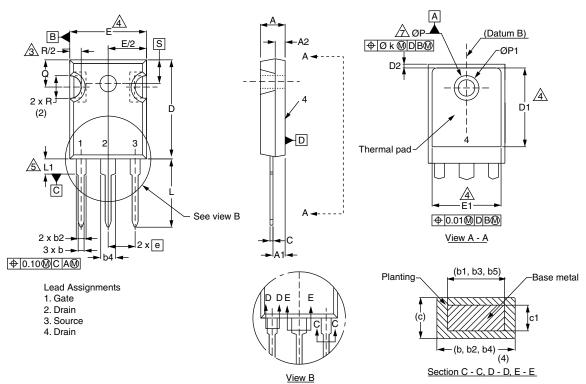


Fig. 19 - For N-Channel

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TO-247AC (High Voltage)



	MILLIMETERS		MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.		
Α	4.58	5.31	0.180	0.209		
A1	2.21	2.59	0.087	0.102		
A2	1.17	2.49	0.046	0.098		
b	0.99	1.40	0.039	0.055		
b1	0.99	1.35	0.039	0.053		
b2	1.53	2.39	0.060	0.094		
b3	1.65	2.37	0.065	0.093		
b4	2.42	3.43	0.095	0.135		
b5	2.59	3.38	0.102	0.133		
С	0.38	0.86	0.015	0.034		
c1	0.38	0.76	0.015	0.030		
D	19.71	20.82	0.776	0.820		
D1	13.08	-	0.515	-		

	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
D2	0.51	1.30	0.020	0.051	
E	15.29	15.87	0.602	0.625	
E1	13.72	ı	0.540	ı	
е	5.46	BSC	0.215 BSC		
Øk	0.2	0.254		0.010	
L	14.20	16.25	0.559	0.640	
L1	3.71	4.29	0.146	0.169	
N	7.62 BSC		0.300 BSC		
ØΡ	3.51	3.66	0.138	0.144	
Ø P1	-	7.39	-	0.291	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51 BSC		0.217 BSC		
0.217 B00					

ECN: X13-0103-Rev. D, 01-Jul-13

DWG: 5971

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Contour of slot optional.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions D1 and E1.
 5. Lead finish uncontrolled in L1.
- 6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").
- 7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.
- 8. Xian and Mingxin actually photo.





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